

# Thermal Reference Point Device

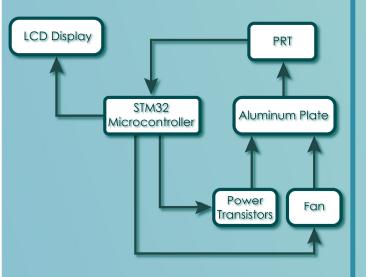
Jose Miranda Luna | Adrian Alcocer | Nikhil DSouza | John Longtir

# Background

Non-contact optical thermometers are becoming increasingly important for both doctor's offices and at home use. However, these devices lose accuracy over time and can be inaccurate to up to  $\pm$  0.5 degrees Celsius. These inaccuracies in a thermometer can potentially lead to a fever being misdiagnosed, which is often a symptom of a more serious, underlying disease. Our device serves as a simple and affordable way to test the accuracy of a thermometer.

# **Project Overview**

The Thermasure is a small heating plate that acts as a temperature reference point device for oprical thermometers. A microcontroller is used to maintain the plate at a stable and uniform temperature. The temperature set point is at 40 degrees celsius to emulate the temperature of a high fever.



# Product Design LCD Temperature Display SketchUp Black Body Heat Plate

## Hardware

### -STM32 Nucleo Board(L301k6):

- -12 bit ADC for measuring PRT voltage
- -PWM capabilities for driving power transistors
- -Data pins for LCD to display temperature to the user

### -Platinum Resistance Thermometer

- -Embedded inside aluminum plate
- -Stable resistance over a wide range of temperatures
- -Linear change in resistance with temperature change

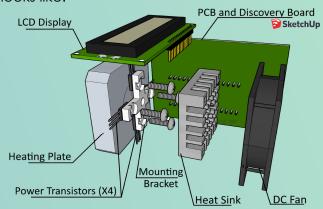
### -IRF540 NFETs

- -Physically mounted on aluminum plate
- -NETs will turn on and off to heat up the plate

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# Results

The device can heat up to the desired temperature in under one minute. Readings are stable well within 0.1°C when the reference point is set to 40°C. Accuracy is improved through noise reducing circuitry and a moving average filter. The PCB Dimensions are 2.5"X3.5" so they are compact enough to fit into a 4"X4"X4" housing, making an easy, light, and portable product. Pictured below is an exploded view of what the inside of the housing looks like.



# **Future Improvements**

- -Integration of the ARM cortex chip rather than the Nucleo board
  - -Smaller PCB footprint as well as cost reduction
- -More reactive PID controls to make response times faster
  - -Faster heat up time as well as increased stability at the set point
- -Implement a programmable reference temperature for a wide range of applications
  - -To be set anywhere between 40°C and 70°C



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UC SANTA BARBARA
College of Engineering